

**G1A-G1M  
1.0AMP SURFACE MOUNT GLASS RECOVERY RECTIFIER**

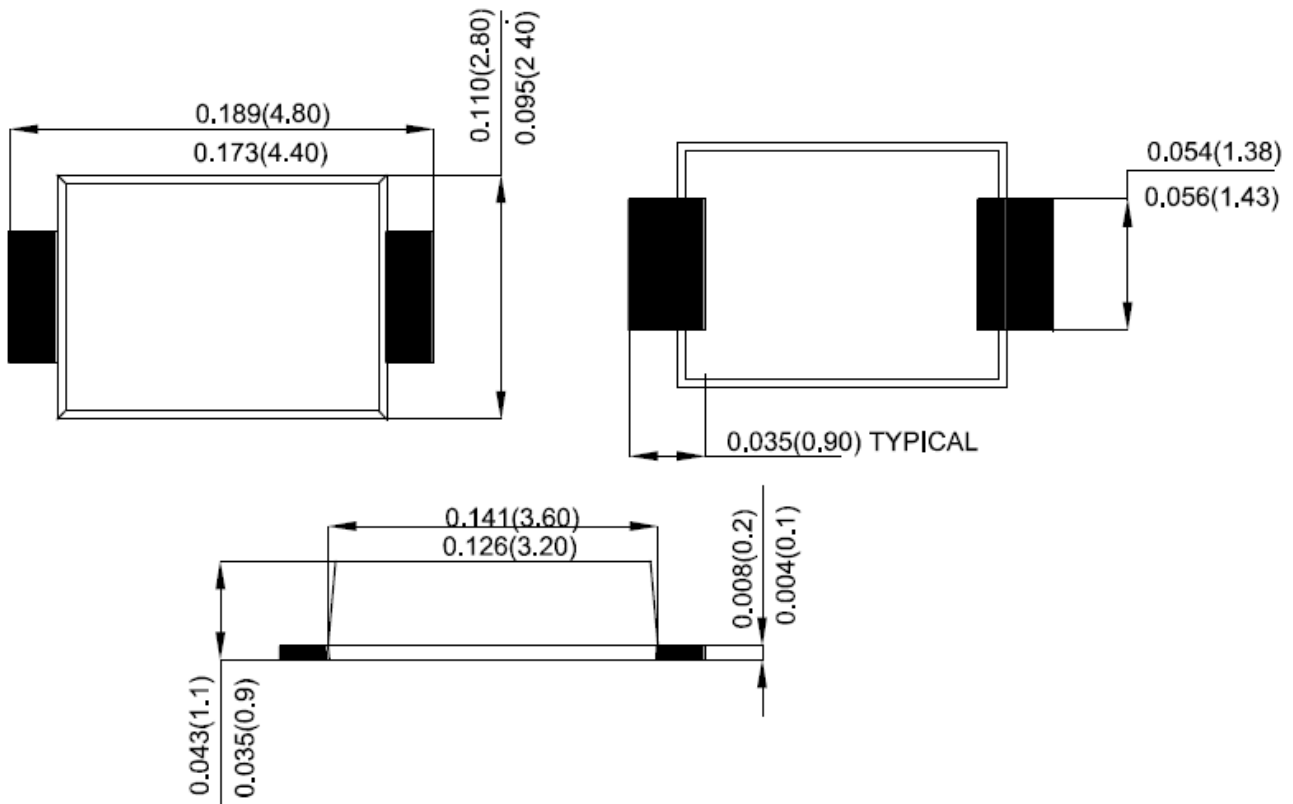
**Features:**

- For surface mounted application
- Low forward voltage drop
- High current capability
- High reliability
- Classification Rating 94V- 0

**Mechanical Data:**

- Case: SMAF, Molded plastic
- Terminals: Plated leads solderable per MIL-STD-750, Method 2026 guaranteed
- Polarity: Color band denotes cathode end
- Mounting Position: Any
- Making: Type Number

**Mechanical Dimensions: In Inches/mm**



**SMAF**

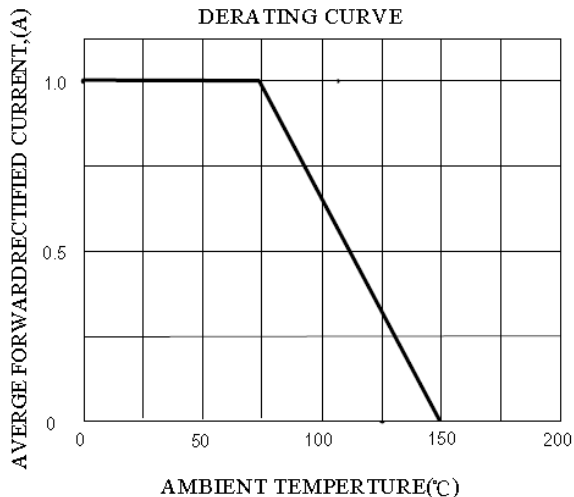
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**Maximum Ratings and Electrical Characteristics @ $T_A=25^\circ\text{C}$  unless otherwise specified**

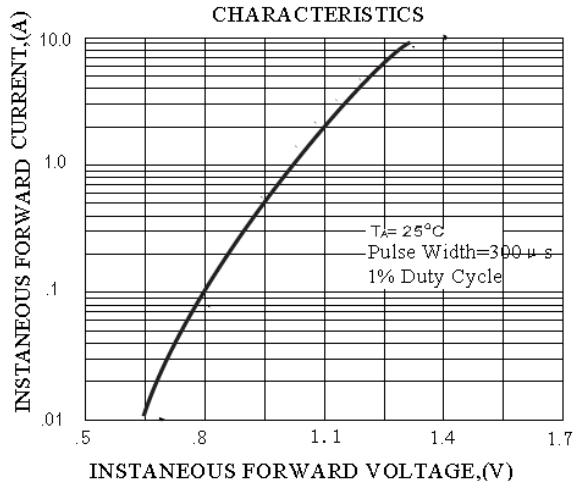
Type Number	Symbol	G1A	G1B	G1D	G1G	G1J	G1K	G1M	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	$V_{RRM}$ $V_{RWM}$ $V_{DC}$	50	100	200	400	600	800	1000	V
RMS Reverse Voltage	$V_{RMS}$	35	70	140	280	420	560	700	V
Average forward rectified output current @ $T_A = 75^\circ\text{C}$	$I_O$	1.0							A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave superimposed on rated load (JEDEC Method)	$I_{FSM}$	35							A
Forward Voltage @ $I_F = 1.0\text{A}$	$V_F$	1.1							V
Peak Reverse Current @ $T_A = 25^\circ\text{C}$ At Rated DC Blocking Voltage @ $T_A = 100^\circ\text{C}$	$I_{RM}$	5.0 500							$\mu\text{A}$
Typical Junction Capacitance (Note 1)	$C_J$	12							pF
Typical Thermal Resistance Junction to Ambient (Note 2)	$R_{\theta JA}$	30							$^\circ\text{C/W}$
Operating and Storage Temperature Range	$T_J, T_{STG}$	-55 to +150							$^\circ\text{C}$
Case Style	SMAF								

Note: 1. Measured at 1.0 MHz and Applied reverse Voltage of 4.0V D.C  
2. Resistance from Junction to Ambient at 0.375(9.5mm) lead length .

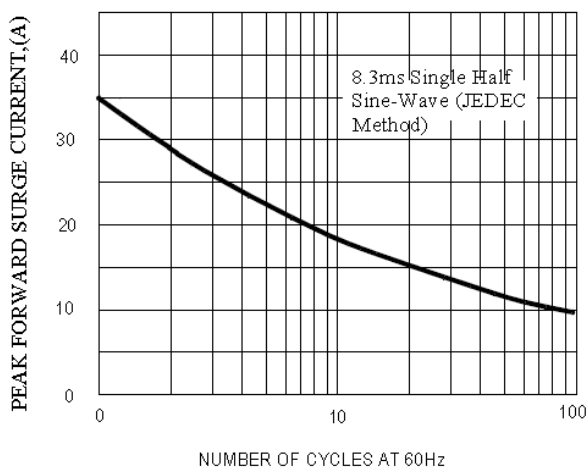
**FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE**



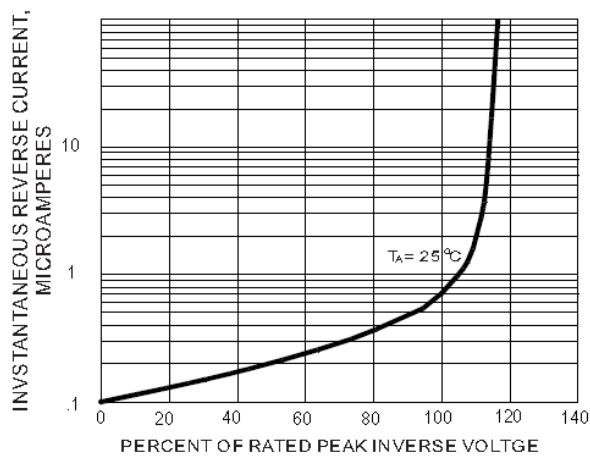
**FIG.2-TYPICAL INSTANTANEOUS FORWARD CHARACTERISTICS**



**FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT**



**FIG.4-TYPICAL REVERSE CHARACTERISTICS**





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